

AOT2500L/AOB2500L

150V N-Channel MOSFET

General Description

The AOT2500L/AOB2500L uses Trench MOSFET technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}},$ Ciss and Coss. This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.

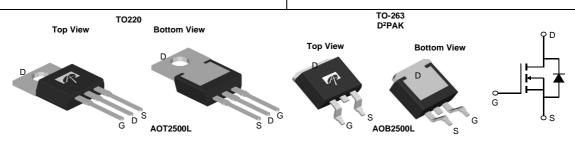
Product Summary

 V_{DS} 150V I_{D} (at V_{GS} =10V) 152A

$$\begin{split} R_{DS(ON)} & (\text{at V}_{GS} \!\!=\!\! 10\text{V}) \\ R_{DS(ON)} & (\text{at V}_{GS} \!\!=\!\! 6\text{V}) \\ \end{split} \qquad < 6.5 \text{m}\Omega \quad (< 6.2 \text{m}\Omega^*) \\ & < 7.6 \text{m}\Omega \quad (< 7.3 \text{m}\Omega^*) \end{split}$$

100% UIS Tested 100% R_g Tested





Absolute Maximum Ratings T₄=25℃ unless otherwise noted

| Parameter | | Symbol | Maximum | Units | |
|--|----------------------|-----------------------------------|------------|-------|--|
| Drain-Source Voltage | | V _{DS} | 150 | V | |
| Gate-Source Voltage | | V _{GS} | ±20 | V | |
| Continuous Drain Current | T _C =25℃ | | 152 | | |
| | T _C =100℃ | I _D | 107 | Α | |
| Pulsed Drain Current ^C | | I _{DM} | 440 | | |
| Continuous Drain Current | T _A =25℃ | | 11.5 | | |
| | T _A =70℃ | IDSM | 9.0 | A | |
| Avalanche Current ^C | | I _{AS} | 65 | A | |
| Avalanche energy L=0.3mH ^C | | E _{AS} | 634 | mJ | |
| | T _C =25℃ | P _D | 375 | W | |
| Power Dissipation ^B | T _C =100℃ | T D | 187.5 | VV | |
| | T _A =25℃ | Р | 2.1 | W | |
| Power Dissipation A | T _A =70℃ | P _{DSM} | 1.3 | VV | |
| Junction and Storage Temperature Range | | T _J , T _{STG} | -55 to 175 | C | |

| Thermal Characteristics | | | | | | | | | |
|---------------------------------------|--------------|-----------------|------|-------|------|--|--|--|--|
| Parameter | Symbol | Тур | Max | Units | | | | | |
| Maximum Junction-to-Ambient A | t ≤ 10s | D | 12 | 15 | ℃/W | | | | |
| Maximum Junction-to-Ambient AD | Steady-State | $R_{\theta JA}$ | 48 | 60 | °C/W | | | | |
| Maximum Junction-to-Case Steady-State | | $R_{\theta JC}$ | 0.26 | 0.4 | ℃/W | | | | |

^{*} Surface mount package TO263



Electrical Characteristics (T_J=25℃ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Тур | Max | Units | | | |
|--|------------------------------------|--|-----|------------|------|-------|--|--|--|
| STATIC PARAMETERS | | | | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V$ | 150 | | | V | | | |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =150V, V _{GS} =0V | | | 1 | μА | | | |
| | Zero Gate Voltage Drain Current | T _J =55℃ | ; | | 5 | | | | |
| I_{GSS} | Gate-Body leakage current | $V_{DS}=0V$, $V_{GS}=\pm20V$ | | | ±100 | nA | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}$, $I_{D}=250\mu A$ | 2.3 | 2.8 | 3.5 | V | | | |
| | Static Drain-Source On-Resistance | V _{GS} =10V, I _D =20A | | 5.4 | 6.5 | | | | |
| | | TO220 T _J =125℃ | ; | 10.2 | 12.3 | mΩ | | | |
| | | $V_{GS}=6V$, $I_D=20A$ | | <i>-</i> 0 | 7.0 | C | | | |
| | | TO220 | | 5.9 | 7.6 | mΩ | | | |
| | | V _{GS} =10V, I _D =20A | | <i>E</i> 1 | 6.2 | mΩ | | | |
| | | TO263 | | 5.1 | | | | | |
| | | $V_{GS}=6V$, $I_D=20A$ | | F.C. | 7.3 | mΩ | | | |
| | | TO263 | | 5.6 | | | | | |
| g FS | Forward Transconductance | V_{DS} =5V, I_{D} =20A | | 70 | | S | | | |
| V_{SD} | Diode Forward Voltage | I _S =1A,V _{GS} =0V | | 0.66 | 1 | V | | | |
| Is | Maximum Body-Diode Continuous Curr | | | 152 | Α | | | | |
| DYNAMI | CPARAMETERS | | | | | | | | |
| C _{iss} | Input Capacitance | | | 6460 | | pF | | | |
| Coss | Output Capacitance | V_{GS} =0V, V_{DS} =75V, f=1MHz | | 586 | | рF | | | |
| C _{rss} | Reverse Transfer Capacitance | 1 | | 22 | | pF | | | |
| R_g | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1MHz | 1 | 2.1 | 3.2 | Ω | | | |
| SWITCH | NG PARAMETERS | - | | | | | | | |
| Q _{g(10V)} | Total Gate Charge | | | 97 | 136 | nC | | | |
| Q_{gs} | Gate Source Charge | V_{GS} =10V, V_{DS} =75V, I_{D} =20A | | 22.5 | | nC | | | |
| Q_{gd} | Gate Drain Charge | 1 | | 17 | | nC | | | |
| t _{D(on)} | Turn-On DelayTime | | | 18.5 | | ns | | | |
| t _r | Turn-On Rise Time | V_{GS} =10V, V_{DS} =75V, R_{L} =3.75 Ω , | | 20 | | ns | | | |
| t _{D(off)} | Turn-Off DelayTime | $R_{GEN}=3\Omega$ | | 67.5 | | ns | | | |
| t _f | Turn-Off Fall Time | 1 | | 14 | | ns | | | |
| t _{rr} | Body Diode Reverse Recovery Time | I _F =20A, dI/dt=500A/μs | | 90 | | ns | | | |
| Q _{rr} | Body Diode Reverse Recovery Charge | l _F =20A, dl/dt=500A/μs | | 1090 | | nC | | | |
| A The value of R., is measured with the device mounted on tin ² FR-4 hoard with 2oz Copper in a still air environment with T. –25° C. The | | | | | | | | | |

A. The value of R_{8JA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The Power dissipation P_{DSM} is based on R _{θJA} and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design, and the maximum temperature of 175° C may be used if the PCB allows it.

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B. The power dissipation P_D is based on $T_{J(MAX)} = 175^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=175° C. Ratings are based on low frequency and duty cycles to keep initial T_J =25° C.

D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

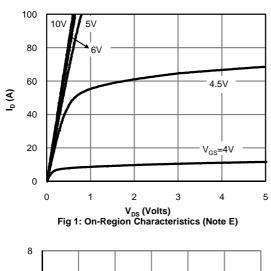
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$ =175 $^{\circ}$ C. The SOA curve provides a single pulse rating.

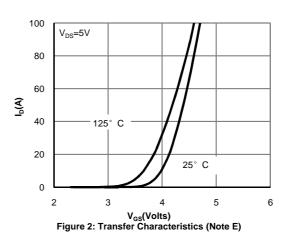
G. The maximum current limited by package.

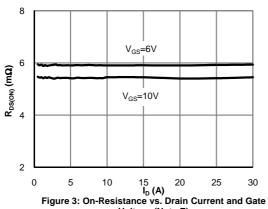
H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C.

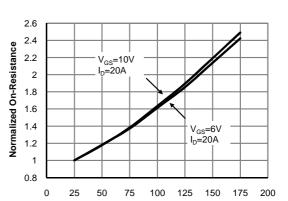


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

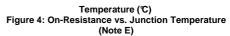


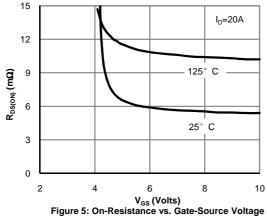


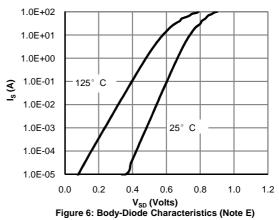




Voltage (Note E)







(Note E)



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

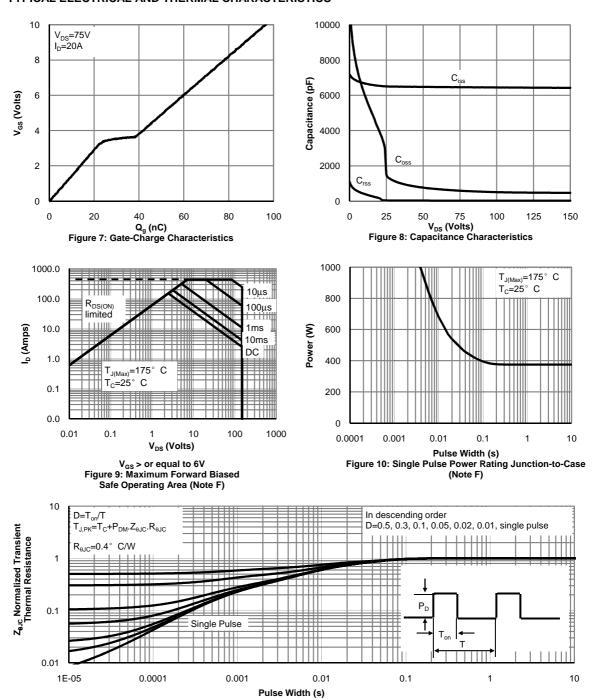
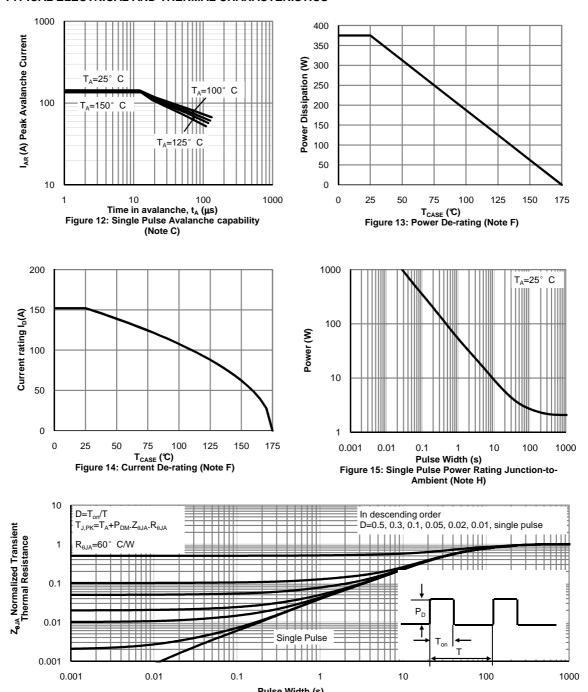


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)



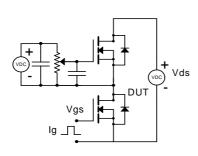
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

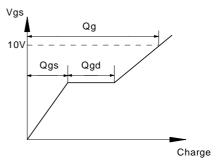


Pulse Width (s)
Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)

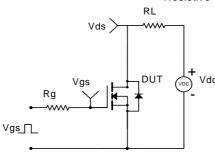


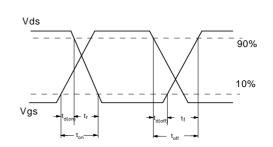
Gate Charge Test Circuit & Waveform



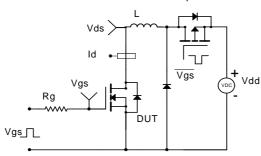


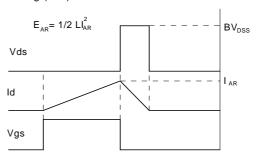
Resistive Switching Test Circuit & Waveforms



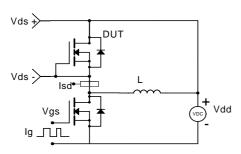


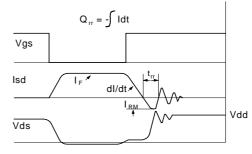
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms





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